RoHS

COMPLIANT

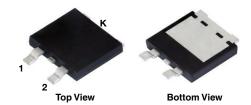
HALOGEN



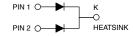
## Vishay General Semiconductor

# Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

### eSMP<sup>®</sup> Series SMPD (TO-263AC)



#### V30D202C



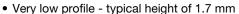
#### **ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 15.0 A			
V <sub>RRM</sub>	200 V			
I <sub>FSM</sub>	260 A			
V <sub>F</sub> at I <sub>F</sub> = 15.0 A (T <sub>A</sub> = 125 °C)	0.66 V			
T <sub>J</sub> max.	175 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Common cathode			

#### **FEATURES**





• Ideal for automated placement

• Low forward voltage drop, low power losses

• High efficiency operation

 Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

• AEC-Q101 qualified available:

- Automotive ordering code: base P/NHM3

 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

#### **MECHANICAL DATA**

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base  $P/NHM3_X$  - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

(X\_denotes revision code e.g. A, B, ...)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30D202C	UNIT	
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	200	V	
Maximum average forward rectified current (fig. 1)	per device	I <sub>F(AV)</sub>	30	۸	
	per diode		15	_ A	
Maximum DC reverse voltage		V <sub>DC</sub>	160	V	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	260	А	
Voltage rate of change (rated V <sub>R</sub> )		dV/dt	10 000	V/µs	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-40 to +175	°C	



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage per diode	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.72	-	V		
	I <sub>F</sub> = 10 A			0.78	-			
	I <sub>F</sub> = 15 A			0.8	0.88			
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.56	-			
	I <sub>F</sub> = 10 A			0.64	-			
	I <sub>F</sub> = 15 A			0.66	0.73			
Reverse current at rated V <sub>R</sub> per diode	V <sub>R</sub> = 160 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	1	-	μA		
		T <sub>A</sub> = 125 °C		2	-	mA		
	V <sub>R</sub> = 200 V	T <sub>A</sub> = 25 °C		-	200	μΑ		
		T <sub>A</sub> = 125 °C		5	25	mA		

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30D202C	UNIT	
	per diode	- R <sub>θJC</sub>	2.0		
Typical thermal resistance	per device		1.1	°C/W	
	per device	R <sub>0</sub> JA (1)(2)	50		

#### **Notes**

(1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$  - junction-to-mount

(2) Free air, without heatsink

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SMPD (TO-263AC)	V30D202C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel
SMPD (TO-263AC)	V30D202CHM3_A/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel

#### Note

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

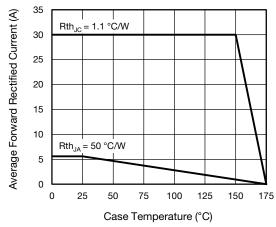


Fig. 1 - Forward Current Derating Curve

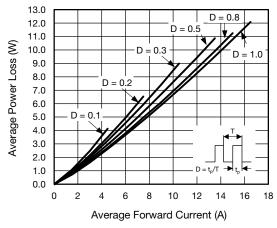


Fig. 2 - Forward Power Loss Characteristics

<sup>(1)</sup> AEC-Q101 qualified



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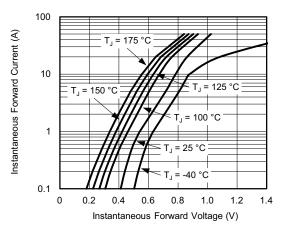


Fig. 3 - Typical Instantaneous Forward Characteristics

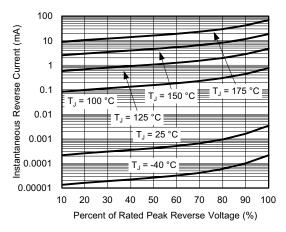


Fig. 4 - Typical Reverse Characteristics

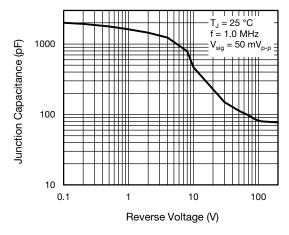


Fig. 5 - Typical Junction Capacitance

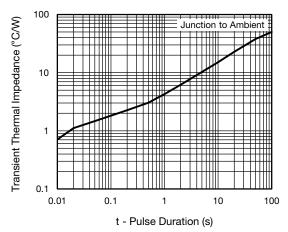


Fig. 6 - Typical Transient Thermal Impedance

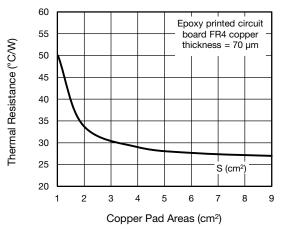
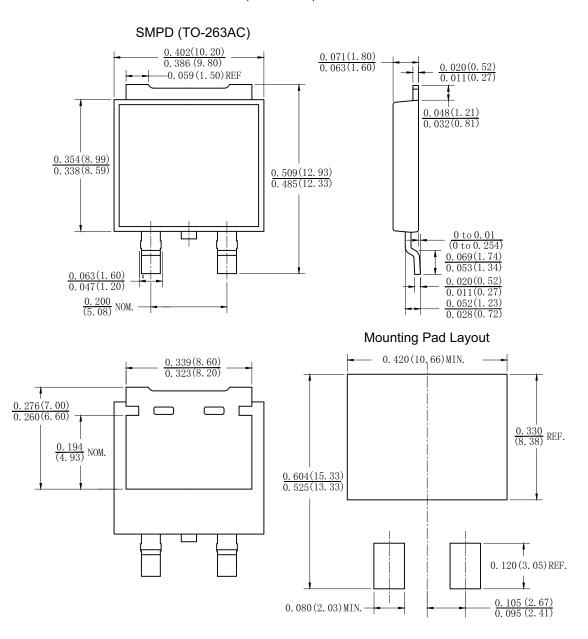


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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